

# 74LVT2241

## 3.3 V octal buffer/line driver with 30 $\Omega$ series termination resistors; 3-state

Rev. 4 — 8 July 2024

Product data sheet

### 1. General description

The 74LVT2241 is an 8-bit buffer/line driver with 3-state outputs. The device can be used as two 4-bit buffers or one 8-bit buffer. The device features two output enables (1 $\overline{OE}$  and 2OE), each controlling four of the 3-state outputs. A HIGH on 1 $\overline{OE}$  or a LOW on 2OE causes the associated outputs to assume a high-impedance OFF-state. Bus hold data inputs eliminate the need for external pull-up resistors to define unused inputs.

### 2. Features and benefits

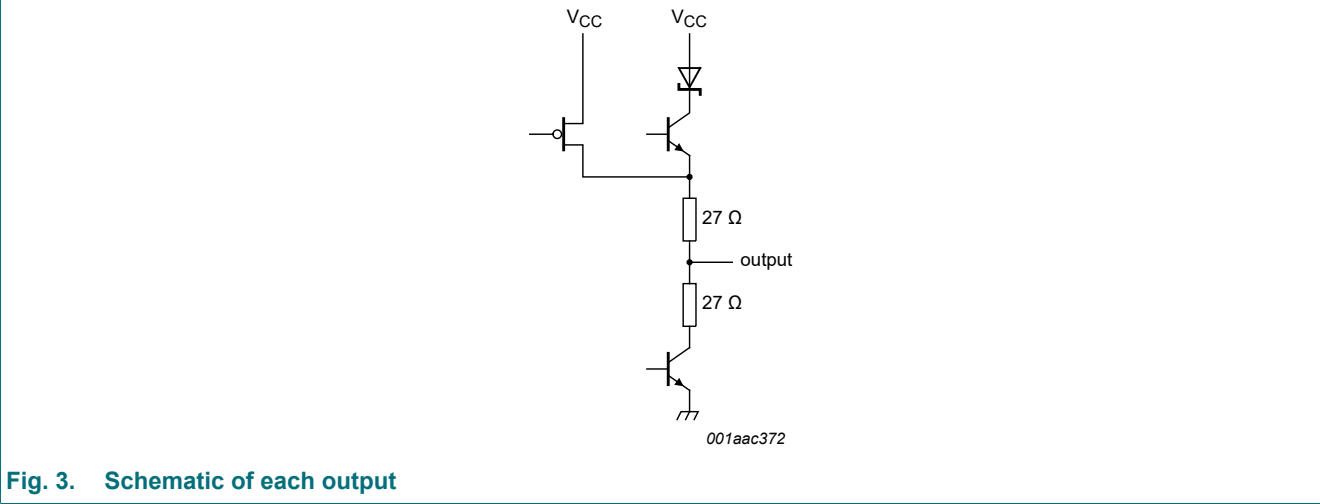
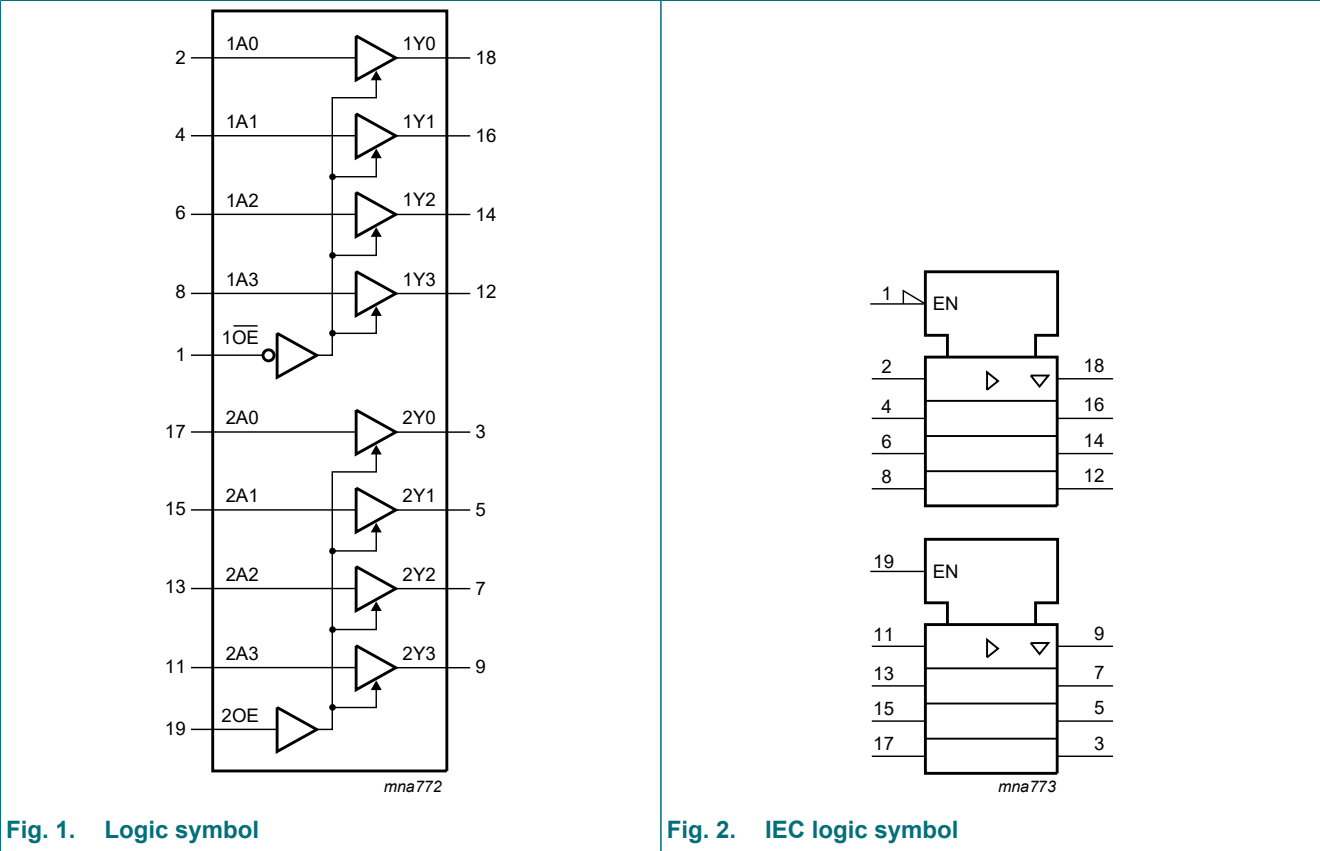
- Octal bus interface
- 3-state buffers
- Wide supply voltage range from 2.7 V to 3.6 V
- BiCMOS high speed and output drive
- Output capability: +12 mA/–12 mA
- Direct interface with TTL levels
- Overvoltage tolerant inputs to 5.5 V
- Input and output interface capability to systems at 5 V supply
- Bus hold data inputs eliminate need for external pull-up resistors to hold unused inputs
- Live insertion and extraction permitted
- Outputs include series resistance of 30  $\Omega$  making external termination resistors unnecessary
- Power-up 3-state
- No bus current loading when output is tied to 5 V bus
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Latch-up performance exceeds 500 mA per JESD 78 Class II Level B
- Complies with JEDEC standards
  - JESD8C (2.7 V to 3.6 V)
- ESD protection:
  - HBM: ANSI/ESDA/JEDEC JS-001 class 2 exceeds 2000 V
  - CDM: ANSI/ESDA/JEDEC JS-002 class C3 exceeds 1000 V
- Specified from -40 °C to +85 °C

### 3. Ordering information

Table 1. Ordering information

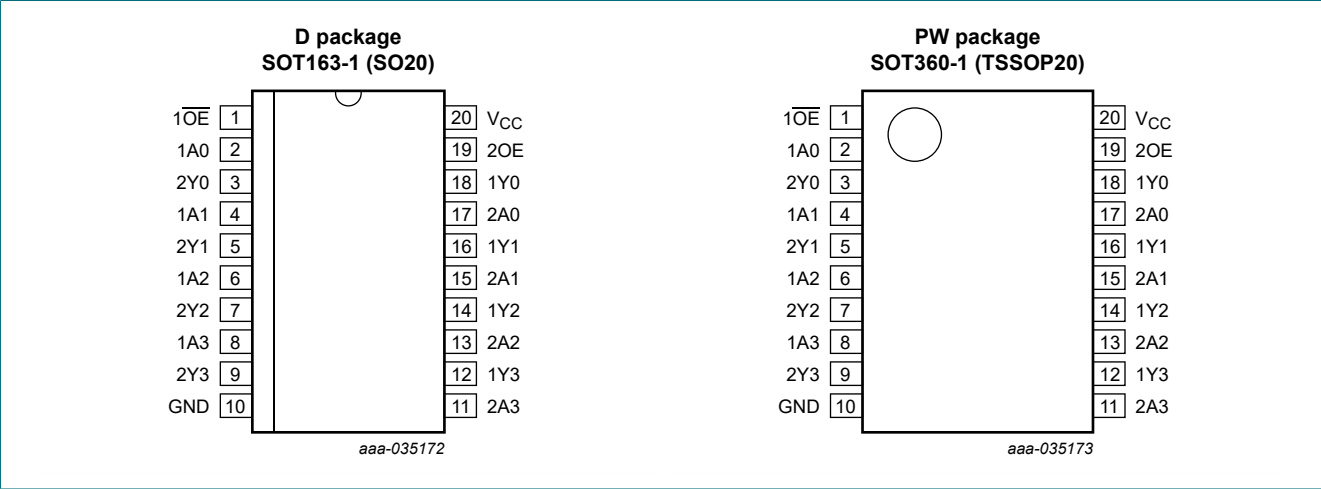
Type number	Package			
	Temperature range	Name	Description	Version
<a href="#">74LVT2241D</a>	-40 °C to +85 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	<a href="#">SOT163-1</a>
<a href="#">74LVT2241PW</a>	-40 °C to +85 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	<a href="#">SOT360-1</a>

4. Functional diagram



5. Pinning information

5.1. Pinning



7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
V <sub>I</sub>	input voltage	[1]	-0.5	+7.0	V
V <sub>O</sub>	output voltage	output in OFF or HIGH state [1]	-0.5	+7.0	V
I <sub>IK</sub>	input clamping current	V <sub>I</sub> < 0 V	-50	-	mA
I <sub>OK</sub>	output clamping current	V <sub>O</sub> < 0 V	-50	-	mA
I <sub>O</sub>	output current	output in LOW state	-	128	mA
		output in HIGH state	-64	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
T <sub>j</sub>	junction temperature	[2]	-	+150	°C

- [1] The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.  
[2] The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		2.7	3.6	V
V <sub>I</sub>	input voltage		0	5.5	V
I <sub>OH</sub>	HIGH-level output current		-12	-	mA
I <sub>OL</sub>	LOW-level output current		-	12	mA
T <sub>amb</sub>	ambient temperature	in free air	-40	+85	°C
Δt/ΔV	input transition rise and fall rate	outputs enabled	-	10	ns/V

## 9. Static characteristics

**Table 6. Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
$V_{IK}$	input clamping voltage	$V_{CC} = 2.7\text{ V}$ ; $I_{IK} = -18\text{ mA}$	-1.2	-0.9	-	V
$V_{IH}$	HIGH-level input voltage		2.0	-	-	V
$V_{IL}$	LOW-level input voltage		-	-	0.8	V
$V_{OH}$	HIGH-level output voltage	$V_{CC} = 3.0\text{ V}$ ; $I_{OH} = -12\text{ mA}$	2.0	2.2	-	V
$V_{OL}$	LOW-level output voltage	$V_{CC} = 3.0\text{ V}$ ; $I_{OL} = 12\text{ mA}$	-	-	0.8	V
$I_I$	input leakage current	all input pins				
		$V_{CC} = 0\text{ V or } 3.6\text{ V}$ ; $V_I = 5.5\text{ V}$	-	1	10	$\mu\text{A}$
		control pins				
		$V_{CC} = 3.6\text{ V}$ ; $V_I = V_{CC}\text{ or GND}$	-	$\pm 0.1$	$\pm 1$	$\mu\text{A}$
		data pins [2]				
		$V_{CC} = 3.6\text{ V}$ ; $V_I = V_{CC}$	-	0.1	1	$\mu\text{A}$
		$V_{CC} = 3.6\text{ V}$ ; $V_I = 0\text{ V}$	-5	-1	-	$\mu\text{A}$
$I_{OFF}$	power-off leakage current	$V_{CC} = 0\text{ V}$ ; $V_I\text{ or } V_O = 0\text{ V to } 4.5\text{ V}$	-	1	$\pm 100$	$\mu\text{A}$
$I_{BHL}$	bus hold LOW current	$V_{CC} = 3.0\text{ V}$ ; $V_I = 0.8\text{ V}$	75	150	-	$\mu\text{A}$
$I_{BHH}$	bus hold HIGH current	$V_{CC} = 3.0\text{ V}$ ; $V_I = 2.0\text{ V}$	-	-150	-75	$\mu\text{A}$
$I_{BHLO}$	bus hold LOW overdrive current	$V_{CC} = 3.6\text{ V}$ ; $V_I = 0\text{ V to } 3.6\text{ V}$ [3]	500	-	-	$\mu\text{A}$
$I_{BHLO}$	bus hold LOW overdrive current	$V_{CC} = 3.6\text{ V}$ ; $V_I = 0\text{ V to } 3.6\text{ V}$ [3]	-	-	-500	$\mu\text{A}$
$I_{EX}$	external current	nYn output in HIGH-state when $V_O > V_{CC}$ ; $V_O = 5.5\text{ V}$ ; $V_{CC} = 3.0\text{ V}$	-	60	125	$\mu\text{A}$
$I_{O(pu/pd)}$	power-up/power-down output current	$V_{CC} \leq 1.2\text{ V}$ ; $V_O = 0.5\text{ V to } V_{CC}$ ; $V_I = \text{GND or } V_{CC}$ ; 1OE, 2OE = don't care [4]	-	$\pm 1$	$\pm 100$	$\mu\text{A}$
$I_{OZ}$	OFF-state output current	$V_{CC} = 3.6\text{ V}$ ; $V_O = 3.0\text{ V}$	-	1	5	$\mu\text{A}$
		$V_{CC} = 3.6\text{ V}$ ; $V_O = 0.5\text{ V}$	-5	-1	-	$\mu\text{A}$
$I_{CC}$	supply current	$V_{CC} = 3.6\text{ V}$ ; $V_I = V_{CC}\text{ or GND}$ ; $I_O = 0\text{ A}$				
		outputs HIGH	-	0.12	0.19	mA
		outputs LOW	-	3	12	mA
		outputs disabled [5]	-	0.12	0.19	mA
$\Delta I_{CC}$	additional supply current	per input pin; $V_{CC} = 3.0\text{ V to } 3.6\text{ V}$ ; one input = $V_{CC} - 0.6\text{ V}$ ; other inputs at $V_{CC}\text{ or GND}$ [6]	-	0.1	0.25	mA
$C_I$	input capacitance	$V_I = 0\text{ V or } 3.0\text{ V}$	-	4	-	pF
$C_O$	output capacitance	outputs disabled; $V_O = 0\text{ V or } 3.0\text{ V}$	-	8	-	pF

[1] All typical values are measured at  $T_{amb} = 25\text{ }^\circ\text{C}$ .

[2] Unused pins at  $V_{CC}$  or GND.

[3] This is the bus hold overdrive current required to force the input to the opposite logic state.

[4] This parameter is valid for any  $V_{CC}$  between 0 V and 1.2 V with a transition time of up to 10 ms.

From  $V_{CC} = 1.2\text{ V to } V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$  a transition time of 100 ms is permitted. This parameter is valid for  $T_{amb} = +25\text{ }^\circ\text{C}$  only.

[5]  $I_{CC}$  with the outputs disabled is measured with outputs pulled to  $V_{CC}$  or GND.

[6] This is the increase in supply current for each input at  $V_{CC} - 0.6\text{ V}$ .

10. Dynamic characteristics

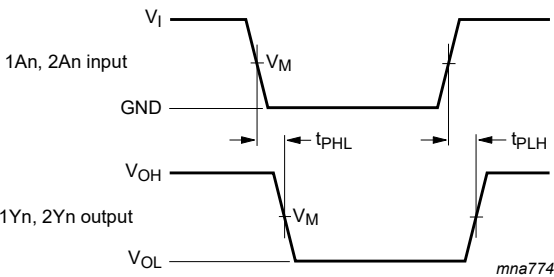
Table 7. Dynamic characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V). For test circuit see Fig. 7.

Symbol	Parameter	Conditions	Min	Typ[1]	Max	Unit
t <sub>PLH</sub>	LOW to HIGH propagation delay	1An to 1Yn, 2An to 2Yn; see Fig. 4				
		V <sub>CC</sub> = 2.7 V	-	-	5.0	ns
		V <sub>CC</sub> = 3.3 V ± 0.3 V	1.0	3.0	4.2	ns
t <sub>PHL</sub>	HIGH to LOW propagation delay	1An to 1Yn, 2An to 2Yn; see Fig. 4				
		V <sub>CC</sub> = 2.7 V	-	-	4.7	ns
		V <sub>CC</sub> = 3.3 V ± 0.3 V	1.0	3.3	4.3	ns
t <sub>PZH</sub>	OFF-state to HIGH propagation delay	1 $\overline{\text{OE}}$ to 1Yn; see Fig. 5				
		V <sub>CC</sub> = 2.7 V	-	-	8.5	ns
		V <sub>CC</sub> = 3.3 V ± 0.3 V	1.0	4.4	6.2	ns
		2OE to 2Yn; see Fig. 6				
		V <sub>CC</sub> = 2.7 V	-	-	7.9	ns
		V <sub>CC</sub> = 3.3 V ± 0.3 V	1.0	4.4	6.2	ns
t <sub>PZL</sub>	OFF-state to LOW propagation delay	1 $\overline{\text{OE}}$ to 1Yn; see Fig. 5				
		V <sub>CC</sub> = 2.7 V	-	-	6.8	ns
		V <sub>CC</sub> = 3.3 V ± 0.3 V	1.0	4.3	5.9	ns
		2OE to 2Yn; see Fig. 6				
		V <sub>CC</sub> = 2.7 V	-	-	6.2	ns
		V <sub>CC</sub> = 3.3 V ± 0.3 V	1.0	4.1	5.5	ns
t <sub>PHZ</sub>	HIGH to OFF-state propagation delay	1 $\overline{\text{OE}}$ to 1Yn; see Fig. 5				
		V <sub>CC</sub> = 2.7 V	-	-	5.2	ns
		V <sub>CC</sub> = 3.3 V ± 0.3 V	1.0	3.4	5.0	ns
		2OE to 2Yn; see Fig. 6				
		V <sub>CC</sub> = 2.7 V	-	-	6.4	ns
		V <sub>CC</sub> = 3.3 V ± 0.3 V	1.0	3.9	5.7	ns
t <sub>PLZ</sub>	LOW to OFF-state propagation delay	1 $\overline{\text{OE}}$ to 1Yn; see Fig. 5				
		V <sub>CC</sub> = 2.7 V	-	-	4.5	ns
		V <sub>CC</sub> = 3.3 V ± 0.3 V	1.6	3.2	4.5	ns
		2OE to 2Yn; see Fig. 6				
		V <sub>CC</sub> = 2.7 V	-	-	5.8	ns
		V <sub>CC</sub> = 3.3 V ± 0.3 V	1.0	3.8	5.1	ns

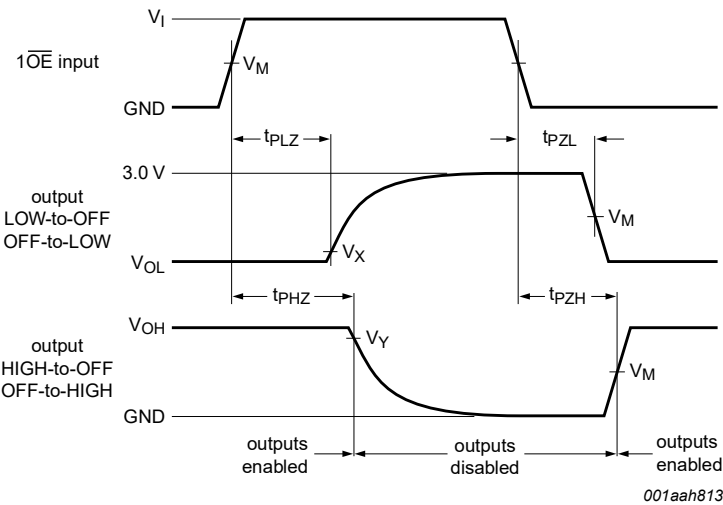
[1] Typical values are measured at T<sub>amb</sub> = 25 °C and V<sub>CC</sub> = 3.3 V.

10.1. Waveforms and test circuit



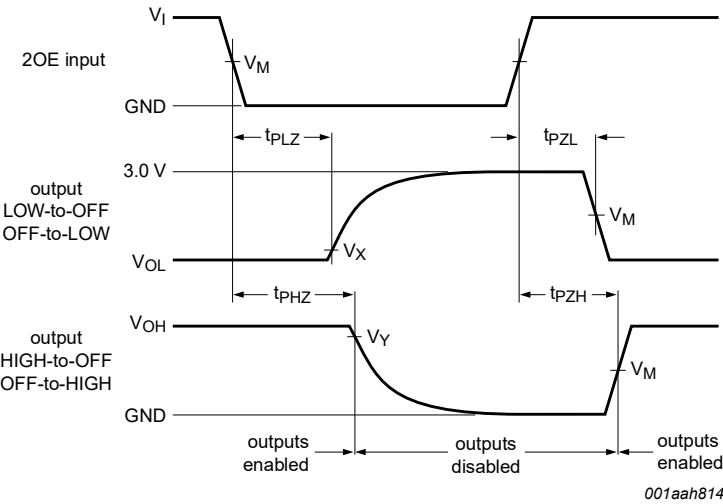
See Table 8 for measurement points.  
 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig. 4. Input (1An, 2An) to output (1Yn, 2Yn) propagation delays



See Table 8 for measurement points.  
 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig. 5. 3-state output (1Yn) enable and disable times



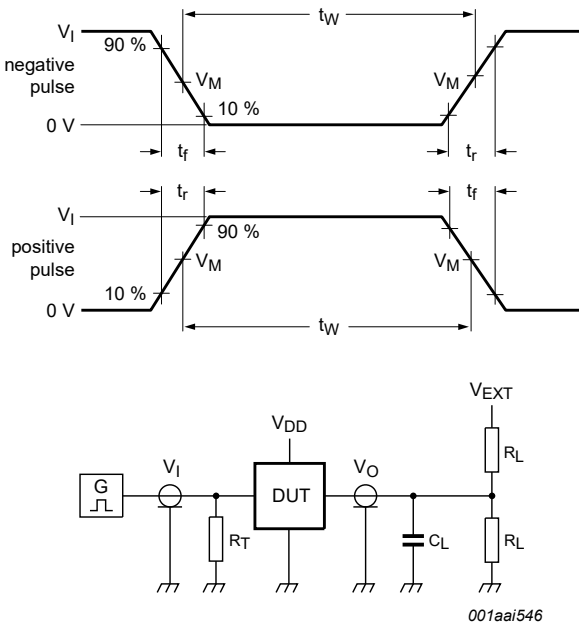
See Table 8 for measurement points.  
 $V_{OL}$  and  $V_{OH}$  are typical output voltage levels that occur with the output load.

Fig. 6. 3-state output (2Yn) enable and disable times

3.3 V octal buffer/line driver with 30 Ω series termination resistors; 3-state

Table 8. Measurement points

Input	Output		
$V_M$	$V_M$	$V_X$	$V_Y$
1.5 V	1.5 V	$V_{OL} + 0.3\text{ V}$	$V_{OH} - 0.3\text{ V}$



Test data is given in [Table 9](#).  
Definitions test circuit:  
 $R_L$  = Load resistance;  
 $C_L$  = Load capacitance including jig and probe capacitance;  
 $R_T$  = Termination resistance should be equal to output impedance  $Z_o$  of the pulse generator;  
 $V_{EXT}$  = External voltage for measuring switching times.

Fig. 7. Test circuit for measuring switching times

Table 9. Test data

Input				Load		$V_{EXT}$		
$V_I$	$f_i$	$t_W$	$t_r, t_f$	$R_L$	$C_L$	$t_{PHZ}, t_{PZH}$	$t_{PLZ}, t_{PZL}$	$t_{PLH}, t_{PHL}$
2.7 V	$\leq 10\text{ MHz}$	500 ns	$\leq 2.5\text{ ns}$	500 Ω	50 pF	GND	6 V	open



11. Package outline

SO20: plastic small outline package; 20 leads; body width 7.5 mm

SOT163-1



Fig. 8. Package outline SOT163-1 (SO20)

3.3 V octal buffer/line driver with 30 Ω series termination resistors; 3-state

TSSOP20: plastic thin shrink small outline package; 20 leads; body width 4.4 mm

SOT360-1

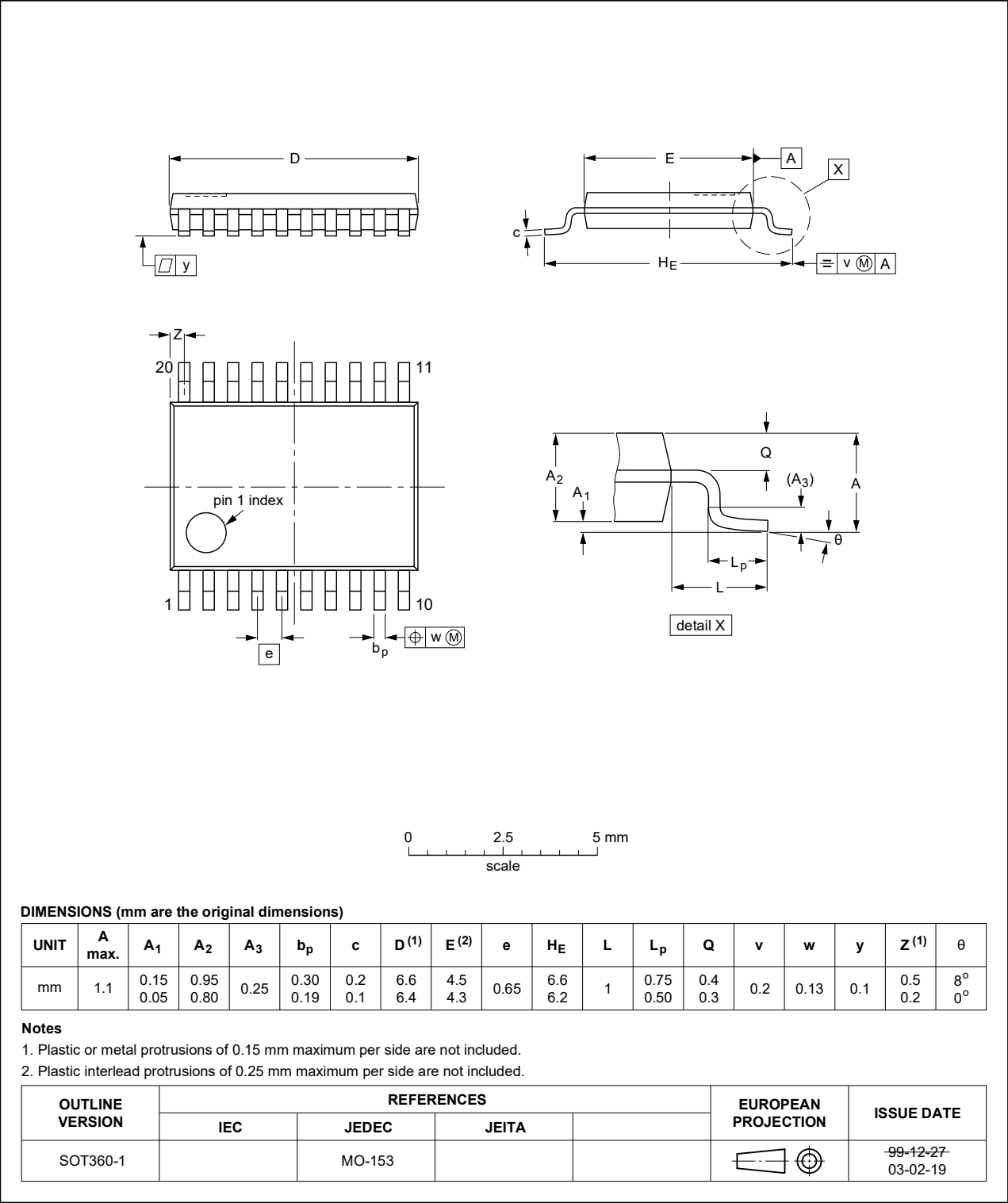


Fig. 9. Package outline SOT360-1 (TSSOP20)

12. Abbreviations

Table 10. Abbreviations

Acronym	Description
ANSI	American National Standards Institute
BiCMOS	Bipolar Complementary Metal Oxide Semiconductor
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
ESDA	ElectroStatic Discharge Association
HBM	Human Body Model
JEDEC	Joint Electron Device Engineering Council
TTL	Transistor-Transistor Logic

13. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74LVT2241 v.4	20240708	Product data sheet	-	74LVT2241 v.3
Modifications:	<ul style="list-style-type: none"><li><a href="#">Section 2</a>: ESD specification updated according to the latest JEDEC standard.</li></ul>			
74LVT2241 v.3	20210217	Product data sheet	-	74LVT2241 v.2
Modifications:	<ul style="list-style-type: none"><li>Type number 74LVT2241DB (SOT339-1 / SSOP20) removed.</li><li><a href="#">Section 1</a> and <a href="#">Section 2</a> updated.</li></ul>			
74LVT2241 v.2	20180503	Product data sheet	-	74LVT2241 v.1
Modifications:	<ul style="list-style-type: none"><li>The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia.</li><li>Legal texts have been adapted to the new company name where appropriate.</li></ul>			
74LVT2241 v.1	19960529	Product specification	-	-

## 14. Legal information

### Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
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